## In the Specification

Please replace paragraph 00034 of the originally submitted specification with the following paragraph:

[90034] Because the generation of excessive heat is a great detriment to the LED and associated circuitry, additional elements can easily be added to the disclosed embodiments such as the incorporation heat sink devices 929 921 or materials in or on the PC board. A metal core PC board 908 is shown in this embodiment to demonstrate the ease in which heat dissipation techniques can be adapted to the aforementioned embodiments.